



**DMN2027USS** 

### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25 ℃
20V	12.5mΩ @ V <sub>GS</sub> = 4.5V	10.5 A
200	19mΩ @ V <sub>GS</sub> = 2.5V	8.5 A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance  $(R_{DS(on)})$  and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

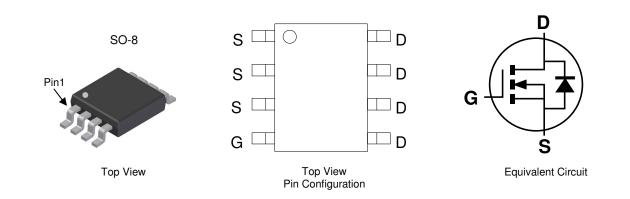
### 20V N-CHANNEL ENHANCEMENT MODE MOSFET

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.076 grams (Approximate)



### Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2027USS-13	SO-8	2,500/Tape & Reel

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

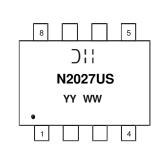
2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

Notes:



SO-8

)'' = Manufacturer's MarkingN2027US = Product Type Marking CodeYYWW = Date Code Marking $YY or <math>\overline{YY}$  = Year (ex: 15 = 2015) WW = Week (01 - 53)



## Maximum Ratings (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic Drain-Source Voltage Gate-Source Voltage			Symbol	<b>Value</b> 20	Units V
			V <sub>DSS</sub>		
			V <sub>GSS</sub>	±12	V
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	Steady State	T <sub>A</sub> = +25℃ T <sub>A</sub> = +70℃	ID	10.5 8.4	A
	t<10s	T <sub>A</sub> = +25 ℃ T <sub>A</sub> = +70 ℃	ID	13.4 10.7	А
Continuous Drain Current (Note 6) $V_{GS}$ = 2.5V	Steady State	T <sub>A</sub> = +25 ℃ T <sub>A</sub> = +70 ℃	ID	8.5 6.8	A
	t<10s	T <sub>A</sub> = +25 ℃ T <sub>A</sub> = +70 ℃	ID	10.9 8.7	А
Maximum Continuous Body Diode Forward Current (Note 6)			IS	6.0	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			IDM	45.0	A
Avalanche Current (Note 7) L = 0.1mH			I <sub>AS</sub>	7.8	А
Avalanche Energy (Note 7) L = 0.1mH			EAS	3.0	mJ

# Thermal Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)		PD	1.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	82	°C/W
mermai Resistance, sunction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}JA}$	48	°C/W
Total Power Dissipation (Note 6)		PD	2.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	60	°C/W
mermai Resistance, sunction to Ambient (Note 6)	t<10s	$R_{ extsf{ heta}JA}$	37	°C/W
Thermal Resistance, Junction to Case		$R_{\theta JC}$	6.4	°C/W
Operating and Storage Temperature Range		T <sub>J</sub> , T <sub>STG</sub>	-55 to 150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	-	-	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-	-	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	-	-	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.7	—	1.3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance		—	_	12.5	mΩ	$V_{GS} = 4.5V, I_D = 9.4A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	—	19	11152	$V_{GS} = 2.5V, I_D = 8.3A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.3	V	$V_{GS} = 0V, I_{S} = 1.3A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	—	1,000	_		$\label{eq:VDS} \begin{split} V_{DS} &= 10V, \ V_{GS} = 0V, \\ f &= 1.0 MHz \end{split}$	
Output Capacitance	Coss	—	166		pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	—	158				
Gate Resistance	Rg	—	1.51	3.2	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 2.5V)	Qg	_	7.0	—			
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	11.6	_	nC	$V_{DS} = 10V, I_D = 9.4A$	
Gate-Source Charge	Q <sub>gs</sub>	_	2.7	—	10		
Gate-Drain Charge	Q <sub>gd</sub>	_	3.4	_			
Turn-On Delay Time	t <sub>D(on)</sub>	_	11.67	—			
Turn-On Rise Time	tr	_	12.49	_		$\label{eq:VGS} \begin{array}{l} V_{GS} = 4.5V,  V_{DS} = 10V, \\ R_G = 6\Omega  ,  I_D = 1A \end{array}$	
Turn-Off Delay Time	t <sub>D(off)</sub>	_	35.89	_	ns		
Turn-Off Fall Time	t <sub>f</sub>	_	12.33	_	]		
Reverse Recovery Time	T <sub>rr</sub>	_	10.8	_	ns		
Reverse Recovery Charge	Q <sub>rr</sub>		5.8	_	nC	I <sub>F</sub> = 12A, di/dt = 500A/μs	

Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

7. I<sub>AS</sub> and E<sub>AS</sub> rating are based on low frequency and duty cycles to keep  $T_J = 25 \,^{\circ}\text{C}$ .

8. Short duration pulse test used to minimize self-heating effect.

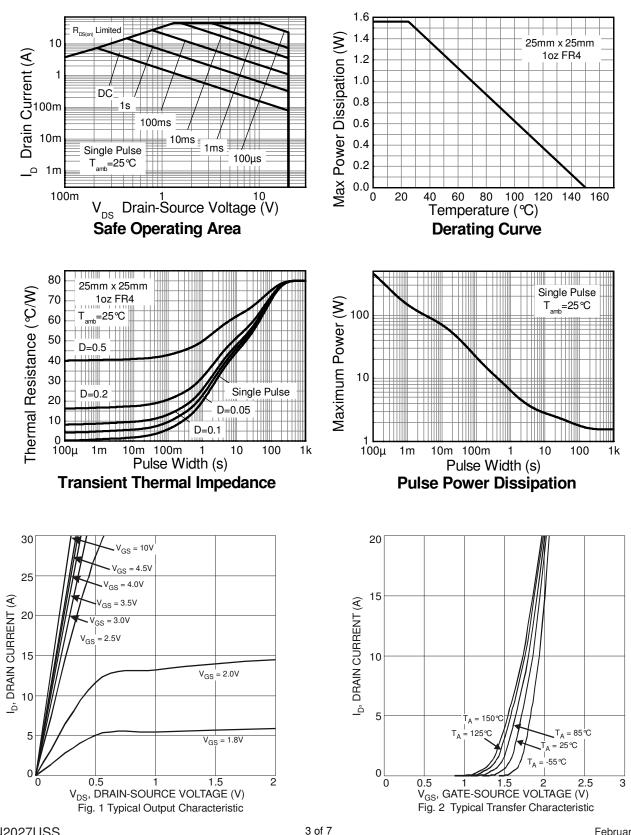
9. Guaranteed by design. Not subject to product testing.

**NEW PRODUCT** 

Notes:



## **Thermal Characteristics**



DMN2027USS Document number: DS35038 Rev. 4 - 2



## **DMN2027USS**

T<sub>A</sub> = 150 ℃

T<sub>A</sub> = 125℃

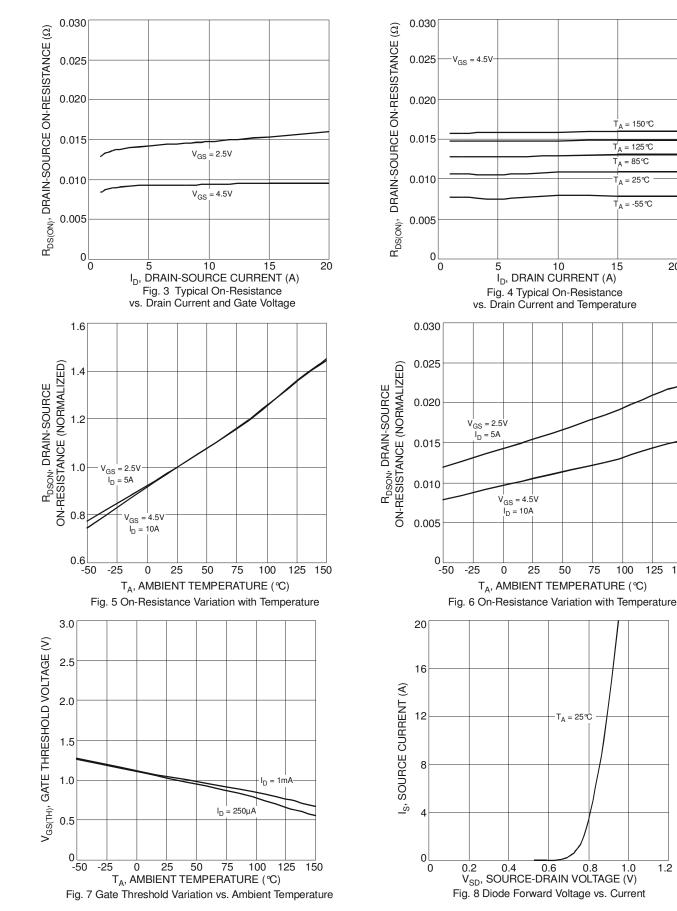
T<sub>A</sub> = 85℃

Ґ<sub>Δ</sub> = -55℃

20

100 125 150

15



NEW PRODUCT

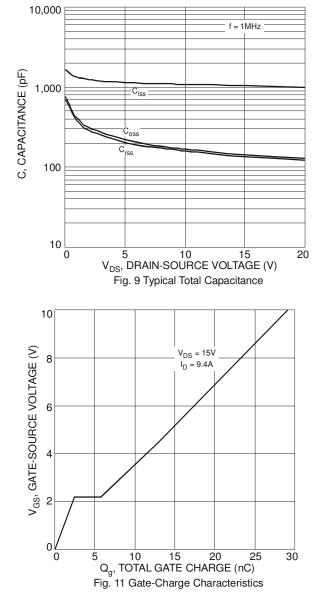
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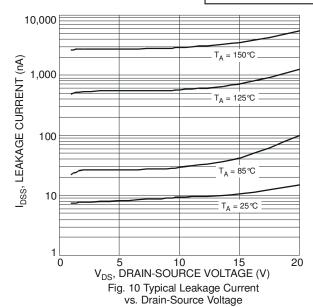
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## DMN2027USS

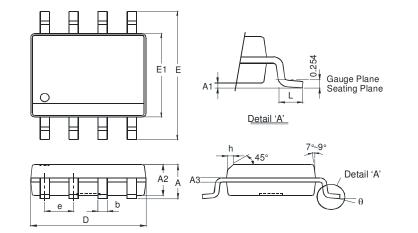






### **Package Outline Dimensions**

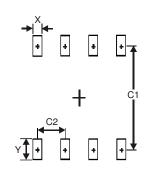
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SO-8				
Dim	Min	Max		
Α	-	1.75		
A1	0.10	0.20		
A2	1.30	1.50		
A3	0.15	0.25		
b	0.3	0.5		
D	4.85	4.95		
Е	5.90	6.10		
E1	3.85	3.95		
е	1.27 Тур			
h	-	0.35		
L	0.62	0.82		
θ	0°	8°		
All Dimensions in mm				

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



SO-8

Dimensions	Value (in mm)			
Х	0.60			
Y	1.55			
C1	5.4			
C2	1.27			



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